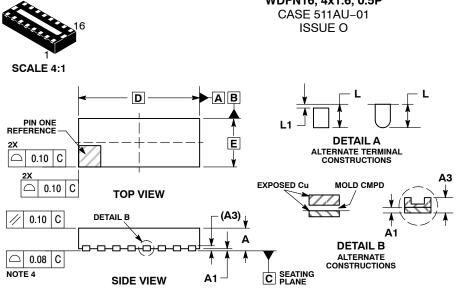
DETAIL A



16X L

0.05

CAB

C NOTE 3

16X **b** 0.10

Ф

WDFN16, 4x1.6, 0.5P

**DATE 06 JUL 2010** 

## NOTES:

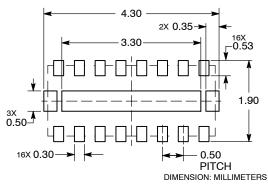
- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.30 MM FROM TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.70	0.80	
A1	0.00	0.05	
А3	0.20 REF		
b	0.20	0.30	
D	4.00 BSC		
D2	3.10	3.30	
Е	1.60 BSC		
E2	0.30	0.50	
е	0.50 BSC		
F	0.25 REF		
K	0.30 REF		
L	0.20	0.40	
L1		0.15	

## **RECOMMENDED SOLDERING FOOTPRINT\***

**BOTTOM VIEW** 

e/2



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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